

## **Power Metal Film Resistors**



#### **FEATURES**

- High power in small packages
- · Different lead materials for different applications
- · Defined interruption behaviour.

#### **APPLICATIONS**

· All general purpose power applications

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, nonflammable lacquer which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes. The encapsulation is resistant to all cleaning solvents in accordance with "MIL-STD-202E, method 215", and "IEC 60068-2-45".

TECHNICAL SPECIFICATIONS							
	VALUE						
DESCRIPTION	PR01	PR0	2	PR0	3		
	1 101	Cu-lead	FeCu-lead	Cu-lead	FeCu-lead		
Resistance range <sup>(3)</sup>	0.22 $\Omega$ to 1 $\text{M}\Omega$	0.33 Ω to 1 MΩ	1 $\Omega$ to 1 M $\Omega$	0.68 Ω to 1 MΩ	1 Ω to 1 MΩ		
Resistance tolerance and series	±	1 % (E24, E96 series)	; ± 5 % (E24 serie	s); see notes 1 and 2			
Maximum dissipation at T <sub>amb</sub> = 70 °C:							
R < 1 Ω	0.6 W	1.2 W	-	1.6 W	-		
1 Ω ≤ R	1 W	2 W	1.3 W	3 W	2.5 W		
Thermal resistance (R <sub>th</sub> )	135 K/W	75 K/W	115 K/W	60 K/W	75 K/W		
Temperature coefficient		:	≤± 250 × 10 <sup>-6</sup> /K				
Maximum permissible voltage (DC or RMS)	350 V	500	V	750 V			
Basic specifications		IEC 6	0115-1 and 6011	5-4			
Climatic category (IEC 60068)			55/155/56				
Stability after:							
load	ΔR/R max.: ± 5 % + 0.1 Ω						
climatic tests	$\Delta$ R/R max.: ± 3 % + 0.1 $\Omega$						
soldering		ΔR/R	max.: ± 1 % + 0.0	5 Ω			

#### **Notes**

- 1. 1 % tolerance is available for R<sub>n</sub>-range from 1R upwards.
- 2. 2 % tolerance is available on request for R<sub>n</sub>-range from 1R upwards.
- 3. Ohmic values (other than resistance range) are available on request.

## Power Metal Film Resistors



12NC ORDERING CODE - indicating resistor type and packaging <sup>(1)</sup> . Preferred types in bold										
				ORDERING CODE 23 (BANDOLIER)						
				AMMOPACK						
TYPE	LEAD Ø	TOL	DADIAI	TAPED		STRAIGH	T LEADS			
	(mm)	(%)	KADIAL	IAPED	52 mm	52 mm	63 mm	52 mm		
			4000 units	3000 units	5000 units	1000 units	500 units	5000 units		
PR01	Cu 0.6	1	_	_	22 196 1	06 191 2	-	06 191 5		
		5	06 197 03	_	22 193 14	06 197 53	_	06 197 23		
PR02	Cu 0.8	1	_	_	-	22 197 1	-	06 192 5		
		5	-	06 198 03	-	06 198 53	-	06 198 23		
	FeCu 0.6	5	_	_	_	22 194 54	_	_		
PR03	Cu 0.8	5	-	-	-	_	22 195 14	-		
		1	_	_	_	_	06 199 6	_		
	FeCu 0.6	5	-	_	_	_	22 195 54	_		

#### Note

<sup>1.</sup> Other packaging versions are available on request.

12NC ORDERING CODE - indicating resistor type and packaging. Preferred types in bold									
				ORDERING CODE 23 (LOOSE IN BOX)					
	LEAD Ø	TOL		DOUBLE	KINK				
TYPE	(mm)	(%)	PITCH = 17.8 (mm)	PITCH = 25.4 (mm)	PITCH	(1)(2)(3)			
	()	(,0)	1000	500	1000	500			
			units	units	units	units			
PR01	Cu 0.6	5	22 193 03	_	_	_			
	FeCu 0.6	5	22 193 43	_	22 193 53 <sup>(1)</sup>	_			
PR02	Cu 0.8	5	22 194 23	_	_	_			
	FeCu 0.6	5	22 194 83	_	_	_			
	FeCu 0.8	5	_	_	<b>22 194 63</b> <sup>(2)</sup>	-			
PR03	Cu 0.8	5	_	22 195 23	_	_			
	FeCu 0.6	5	_	22 195 83	_	-			
	FeCu 0.8	5	_	_	_	22 195 63 <sup>(3)</sup>			

#### **Notes**

- 1. PR01 pitch 12.5 mm.
- 2. PR02 pitch 15.0 mm.
- 3. PR03 pitch 20.0 mm, with reversed kinking direction as opposed to the drawing for the type with double kink figure.

#### **ORDERING INFORMATION**

#### **Ordering Code (12NC)**

The resistors have a 12-digit ordering code starting with 23. For 5 % tolerance:

- The first 9 digits indicate the resistor type and packaging.
- The remaining 3 digits indicate the resistance value:
  - The first 2 digits indicate the resistance value.
  - The last digit indicates the resistance decade.

#### For 1% tolerance:

- · The first 8 digits indicate the resistor type and packaging.
- The remaining 4 digits indicate the resistance value:
  - The first 3 digits indicate the resistance value.
  - The last digit indicates the resistance decade.

#### Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.22 to 0.91 Ω	7
1 to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
1 to 9.76 kΩ	2
10 to 97.6 kΩ	3
100 to 976 kΩ	4
1 MΩ	5

#### **Ordering Example**

The ordering code for resistor type PR02 with Cu leads and a value of 750  $\Omega$  with 5 % tolerance, supplied on a bandolier of 1000 units in ammopack, is: 2306 198 53751.

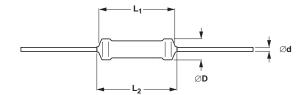
For technical questions contact: <u>ff3dresistors@vishay.com</u>

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Revision: 24-Feb-04

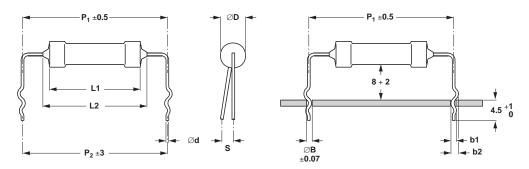


#### **DIMENSIONS**



Type with straight leads.

<b>DIMENSIONS</b> - straight lead type and relevant physical dimensions; see straight leads outline						
TYPE	ØD MAX.	L <sub>1</sub> MAX.	L <sub>2</sub>	Ød (mm)		
	(mm)	(mm)	(mm)	Cu	FeCu	
PR01	2.5	6.5	8.5	0.58 ± 0.05	-	
PR02	3.9	10.0	12.0	0.78 ± 0.05	0.58 ± 0.05	
PR03	5.2	16.7	19.5	0.78 ± 0.05	0.58 ± 0.05	



Type with double kink.

Dimensions in millimeters.

DIME	<b>DIMENSIONS</b> - double kink lead type and relevant physical dimensions; see double kinked outline									
TYPE	LEAD STYLE	Ød AD STYLE (mm) b1		b1 (mm)	b2 (mm)	ØD MAX.	MAX. P <sub>1</sub> P <sub>2</sub>		S MAX.	ØB (mm)
		Cu	FeCu	(11111)	(11111)	(mm)	(mm)	(mm)	(mm)	(11111)
PR01	double kink large pitch	0.58 ± 0.05	0.58 ± 0.05	1.10 + 0.25/-0.20	1.45 + 0.25/-0.20	2.5	17.8	17.8	2	0.8
FHOT	double kink small pitch	-	0.58 ± 0.05	1.10 + 0.25/-0.20	1.45 + 0.25/–0.20	2.5	12.5	12.5	2	0.8
PR02	double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/-0.20	1.45 + 0.25/-0.20		17.8	17.8	2	0.8
FN02	double kink small pitch	-	0.78 ± 0.05	1.30 + 0.25/-0.20	1.65 + 0.25/-0.20	3.9	17.8	17.8	2	1.0
PR03	double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/-0.20	1.65 + 0.25/-0.20	5.2	25.4	25.4	2	1.0
rnu3	double kink small pitch	-	0.78 ± 0.05	1.30 + 0.25/-0.20	2.15 + 0.25/-0.20	3.2	22.0	20.0	2	1.0

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### Power Metal Film Resistors



MASS PER 100 UNITS			
TYPE	MASS		
1112	(g)		
PR01	28		
PR02	62		
PR03	120		

#### **MARKING**

The nominal resistance and tolerance are marked on the resistor using four coloured bands in accordance with IEC publication 60062, "Colour codes for fixed resistors".

#### **OUTLINES**

The length of the body  $(L_1)$  is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation ("IEC publication 60294").

#### **MOUNTING**

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines.

MOUNTING PITCH						
TYPE	LEAD STYLE	PITCH				
ITPE	LEAD STILE	mm	е			
PR01	straight leads	12.5 <sup>(1)</sup>	5(1)			
	radial taped	4.8	2			
	double kink large pitch	17.8	7			
	double kink small pitch	12.5	5			
PR02	straight leads	15.0 <sup>(1)</sup>	6(1)			
	radial taped	4.8	2			
	double kink large pitch	17.8	7			
	double kink small pitch	15.0	6			
PR03	straight leads	23.0(1)	9(1)			
	double kink large pitch	25.4	10			
	double kink small pitch	20.0	8			

#### Note

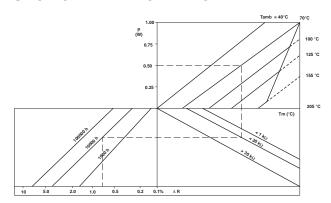
1. Recommended minimum value.

#### **FUNCTIONAL DESCRIPTION**

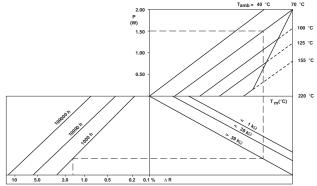
#### **PRODUCT CHARACTERIZATION**

Standard values of nominal resistance are taken from the E96/E24 series for resistors with a tolerance of  $\pm$  1 % or  $\pm$  5 %. The values of the E96/E24 series are in accordance with "IEC publication 60063".

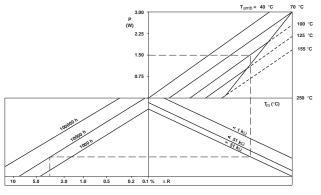
#### **FUNCTIONAL PERFORMANCE**



PR01 Drift nomogram.



PR02 Drift nomogram.



PR03 Drift nomogram.

LIMITING VALUES						
TYPE	LEAD MATERIAL	RANGE	LIMITING VOLTAGE <sup>(1)</sup> (V)	LIMITING POWER (W)		
PR01	Cu	R<1Ω	350	0.6		
1 1101		1 Ω ≤ R		1.0		
	Cu	R < 1 Ω		1.2		
PR02	Ou	1 Ω ≤ R	500	2.0		
	FeCu	1 Ω ≤ R		1.3		
	Cu	R < 1 Ω		1.6		
PR03	Ou	1 Ω ≤ R	750	3.0		
	FeCu	1 Ω ≤ R		2.5		

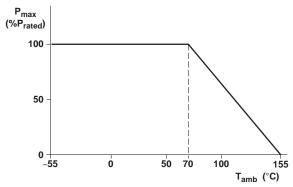
#### Note

 The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-1".

The maximum permissible hot-spot temperature is 205  $^{\circ}$ C for PR01, 220  $^{\circ}$ C for PR02 and 250  $^{\circ}$ C for PR03.

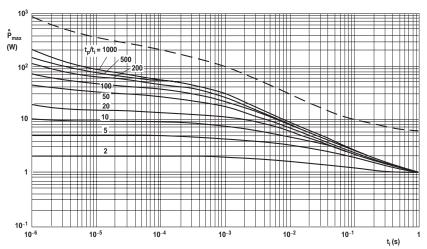


The power that the resistor can disipate depends on the operating temperature.

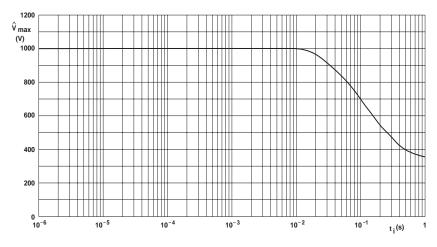


Maximum dissipation ( $P_{max}$ ) in percentage of rated power as a function of the ambient temperature ( $T_{amb}$ ).

### **Derating**



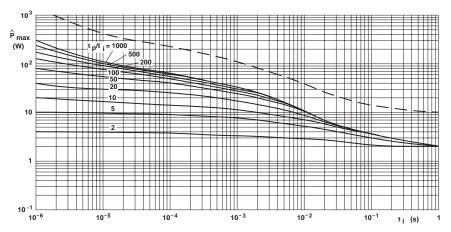
 $\textbf{PR01} \text{ Pulse on a regular basis; maximum permissible peak pulse power } (\hat{P}_{max}) \text{ as a function of pulse duration } (t_i).$ 



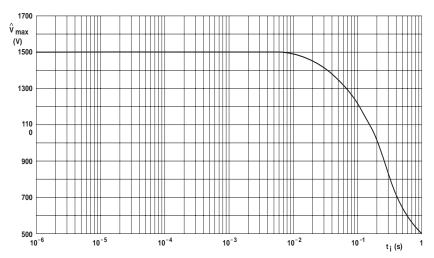
 $\textbf{PR01} \text{ Pulse on a regular basis; maximum permissible peak pulse voltage } (\hat{V}_{max}) \text{ as a function of pulse duration } (t_i).$ 

#### **Pulse Loading Capabilities**

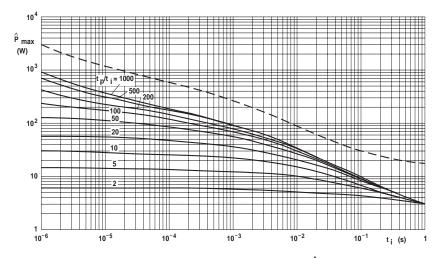




 $\textbf{PR02} \ \text{Pulse on a regular basis; maximum permissible peak pulse power} \ (\hat{P}_{max}) \ \text{as a function of pulse duration } (t_i).$ 



**PR02** Pulse on a regular basis; maximum permissible peak pulse voltage  $(\hat{V}_{max})$  as a function of pulse duration  $(t_i)$ .

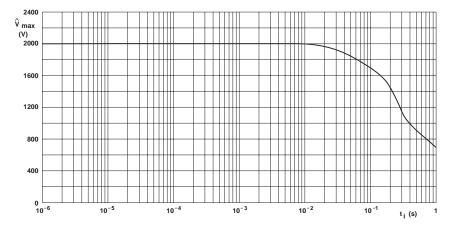


**PR03** Pulse on a regular basis; maximum permissible peak pulse power  $(\hat{P}_{max})$  as a function of pulse duration  $(t_i)$ .

#### **Pulse Loading Capabilities**

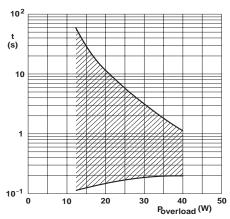


## Vishay BCcomponents



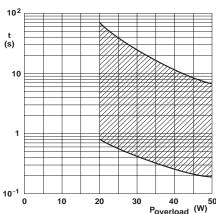
**PR03** Pulse on a regular basis; maximum permissible peak pulse voltage  $(\hat{V}_{max})$  as a function of pulse duration  $(t_i)$ .

### **Pulse Loading Capabilities**



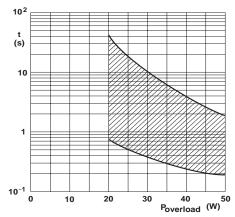
**PR01** Time to interruption as a function of overload power for range:  $0 R 22 \le R_n < 1 R$ .

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



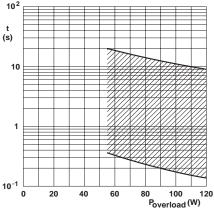
**PR01** Time to interruption as a function of overload power for range:  $16 \text{ R} \le R_n \le 560 \text{ R}$ .

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



**PR01** Time to interruption as a function of overload power for range:  $1 R \le R_n \le 15 R$ .

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



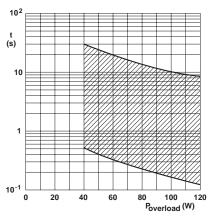
**PR02** Time to interruption as a function of overload power for range:  $0.33 \text{ R} \le R_n < 5 \text{ R}$ .

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

#### **Interruption Characteristics**

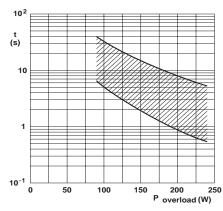
### Power Metal Film Resistors





**PR02** Time to interruption as a function of overload power for range:  $5 R \le R_n < 68 R$ .

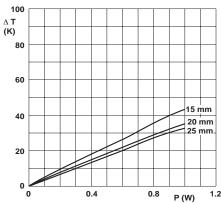
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



**PR03** Time to interruption as a function of overload power for range: 0.68 R  $\leq$  R<sub>n</sub>  $\leq$  560 R.

This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

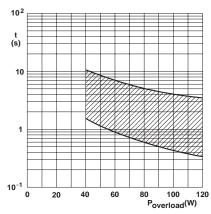
### **Interruption Characteristics**



Ø0.6 mm Cu-leads.

Minimum distance from resistor body to PCB = 1 mm.

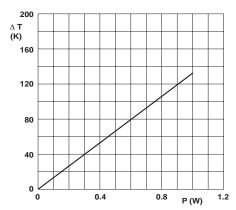
**PR01** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



**PR02** Time to interruption as a function of overload power for range:  $68 \text{ R} \le R_n \le 560 \text{ R}$ .

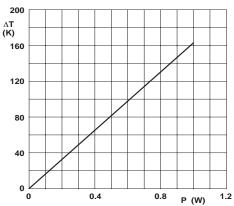
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

#### Interruption Characteristics



Ø0.6 mm Cu-leads.

**PR01** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.



Ø0.6 mm FeCu-leads.

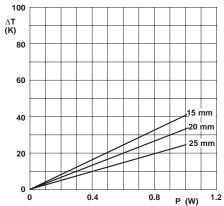
**PR01** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.

### **Application Information**

www.vishay.com



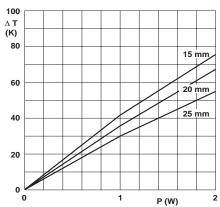
## Vishay BCcomponents



Ø0.6 mm FeCu-leads.

Minimum distance from resistor body to PCB = 1 mm.

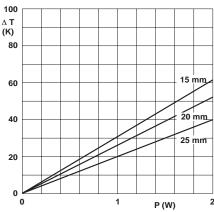
**PR01** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.8 mm Cu-leads.

Minimum distance from resistor body to PCB = 1 mm.

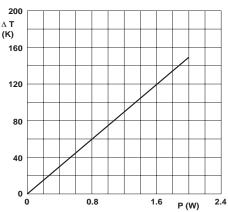
**PR02** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.6 mm FeCu-leads.

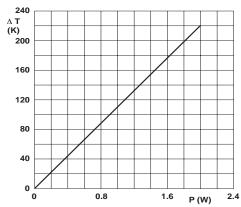
Minimum distance from resistor body to PCB = 1 mm.

**PR02** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



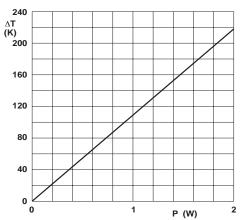
Ø0.8 mm Cu-leads.

**PR02** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.



Ø0.6 mm FeCu-leads.

**PR02** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.

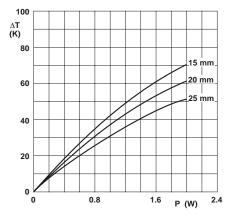


Ø0.8 mm FeCu-leads.

**PR02** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.

## Power Metal Film Resistors

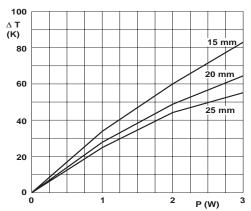




Ø0.8 mm FeCu-leads.

Minimum distance from resistor body to PCB = 1 mm.

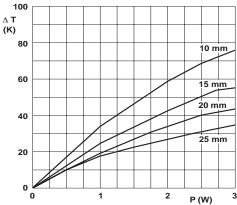
**PR02** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.8 mm Cu-leads.

Minimum distance from resistor body to PCB = 1 mm.

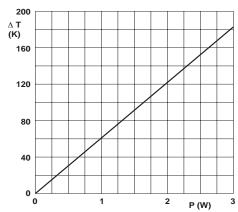
**PR03** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.6 mm FeCu-leads.

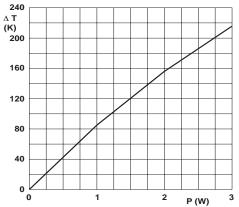
Minimum distance from resistor body to PCB = 1 mm.

**PR03** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



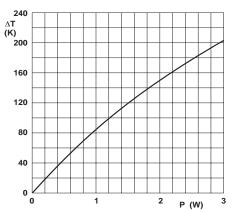
Ø0.8 mm Cu-leads.

PR03 Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.



Ø0.6 mm FeCu-leads.

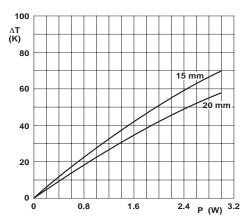
**PR03** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.



Ø0.8 mm FeCu-leads.

**PR03** Hot-spot temperature rise ( $\Delta T$ ) as a function of dissipated power.

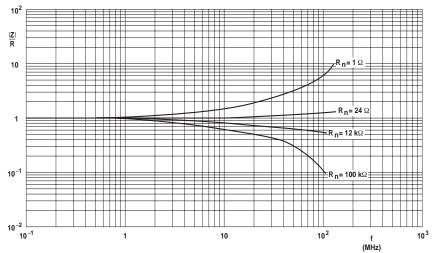




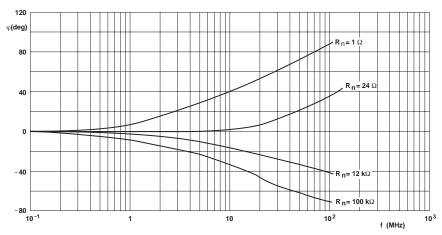
Ø0.8 mm FeCu-leads.

Minimum distance from resistor body to PCB = 1 mm.

**PR03** Temperature rise ( $\Delta T$ ) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

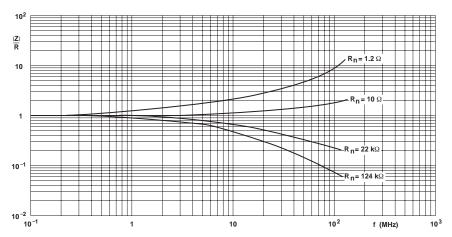


PR01 Impedance as a function of applied frequency.

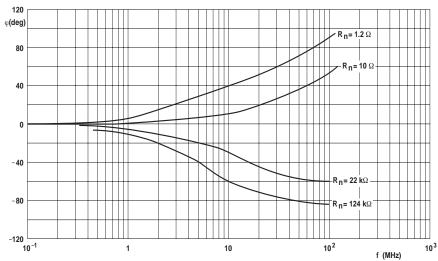


PR01 Phase angle as a function of applied frequency.

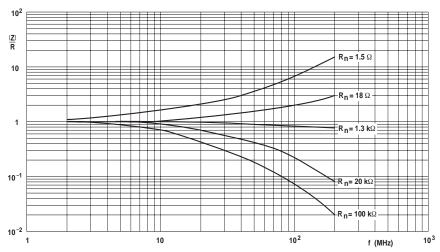




PR02 Impedance as a function of applied frequency.

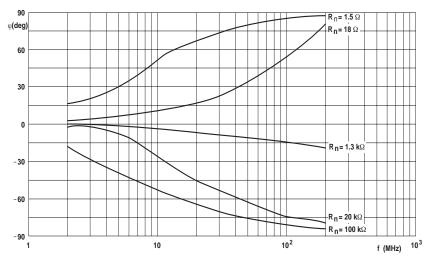


PR02 Phase angle as a function of applied frequency.



PR03 Impedance as a function of applied frequency.





PR03 Phase angle as a function of applied frequency.

### **Application Information**

#### **TESTS AND REQUIREMENTS**

Essentially all tests are carried out in accordance with the schedule of "IEC publication 60115-1", category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068-2, "Recommended basic climatic and mechanical robustness testing procedure for electronic components"

and under standard atmospheric conditions according to "IEC 60068-1", subclause 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of "IEC publications 60115-1 and 60068-2"; a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

TEST P	TEST PROCEDURES AND REQUIREMENTS					
IEC 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS		
TESTS IN	ACCORDANC	E WITH THE SCHEDULE	OF IEC PUBLICATION 60115-1			
4.4.1		visual examination		no holes; clean surface; no damage		
4.4.2		dimensions (outline)	gauge (mm)	see Straight & Kinked Dimensions tables		
4.5		resistance	applied voltage (+ 0/–10 %): $R < 10 \ \Omega : 0.1 \ V$ $10 \ \Omega \le R < 100 \ \Omega : 0.3 \ V$ $100 \ \Omega \le R < 1 \ k\Omega : 1 \ V$ $1 \ k\Omega \le R < 10 \ k\Omega : 3 \ V$ $10 \ k\Omega \le R < 100 \ k\Omega : 10 \ V$ $100 \ k\Omega \le R < 1 \ M\Omega : 25 \ V$ $R = 1 \ M\Omega : 50 \ V$	R – R <sub>nom</sub> : max. ± 5 %		
4.18	20 (Tb)	resistance to soldering heat	thermal shock: 3 s; 350 °C; 3 mm from body	ΔR/R max.: ± 1 % + 0.05 Ω		
4.29	45 (Xa)	component solvent resistance	isopropyl alcohol or H <sub>2</sub> O followed by brushing in accordance with <i>"MIL 202 F"</i>	no visual damage		
4.17	20 (Ta)	solderability	2 s; 235 °C	good tinning; no damage		
4.7		voltage proof on insulation	maximum voltage 500 V (RMS) during 1 minute; metal block method	no breakdown or flashover		

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## Power Metal Film Resistors



TEST P	TEST PROCEDURES AND REQUIREMENTS						
IEC 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS			
4.16	21 (U)	robustness of terminations:					
4.16.2	21 (Ua1)	tensile all samples	load 10 N; 10 s	number of failures: $< 1 \times 10^{-6}$			
4.16.3	21 (Ub)	bending half number of samples	load 5 N; 4 × 90°	number of failures: $< 1 \times 10^{-6}$			
4.16.4	21 (Uc)	torsion other half of samples	3 × 360° in opposite directions	no damage $\Delta R/R$ max.: $\pm$ 0.5 % + 0.05 $\Omega$			
4.20	29 (Eb)	bump	3 x 1500 bumps in three directions; 40 g	no damage $\Delta$ R/R max.: ± 0.5 % + 0.05 $\Omega$			
4.22	6 (Fc)	vibration	frequency 10 to 500 Hz; displacement 1.5 mm or acceleration 10 g; three directions; total 6 hours (3 × 2 hours)	no damage $\Delta$ R/R max.: ± 0.5 % + 0.05 $\Omega$			
4.19	14 (Na)	rapid change of temperature	30 minutes at LCT and 30 minutes at UCT; 5 cycles	no visual damage <b>PR01</b> : $\Delta$ R/R max.: $\pm$ 1 % $\pm$ 0.05 $\Omega$ <b>PR02</b> : $\Delta$ R/R max.: $\pm$ 1 % $\pm$ 0.05 $\Omega$ <b>PR03</b> : $\Delta$ R/R max.: $\pm$ 2 % $\pm$ 0.05 $\Omega$			
4.23		climatic sequence:					
4.23.3	30 (Db)	damp heat (accelerated) 1 <sup>st</sup> cycle					
4.23.6	30 (Db)	damp heat (accelerated) remaining cycles	6 days; 55 °C; 95 to 98 % RH	$R_{ins}$ min.: 10 $^3$ M $\Omega$ $\Delta$ R/R max.: ± 3 % + 0.1 $\Omega$			
4.24.2	3 (Ca)	damp heat (steady state) (IEC)	56 days; 40 °C; 90 to 95% RH; loaded with 0.01 P <sub>n</sub> (IEC steps: 4 to 100 V)	$R_{ins}$ min.: 1000 MΩ $\Delta$ R/R max.: ± 3 % + 0.1 Ω			
4.25.1		endurance (at 70 °C)	1 000 hours; loaded with P <sub>n</sub> or V <sub>max</sub> ; 1.5 hours on and 0.5 hours off	$\Delta$ R/R max.: ± 5 % + 0.1 $\Omega$			
4.8.4.2		temperature coefficient	at 20/LCT/20 °C and 20/UCT/20 °C (TC × 10 <sup>-6</sup> /K)	≤± 250			
OTHER TE	STS IN ACC	DRDANCE WITH IEC 601	15 CLAUSES AND IEC 60068 TEST METHOD				
4.17	20 (Tb)	solderability (after ageing)	8 hours steam or 16 hours 155 °C; leads immersed 6 mm for 2 $\pm$ 0.5 s in a solder bath at 235 $\pm$ 5 °C	good tinning (≥ 95 % covered); no damage			
4.6.1.1		insulation resistance	maximum voltage (DC) after 1 minute; metal block method	R <sub>ins</sub> min.: 10 <sup>4</sup> MΩ			
see 2 <sup>nd</sup> am IEC 60115	endment to -1,Jan. '87	pulse load		see Pulse Load Capabilities graphs			

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